



P-Channel 2.5-V (G-S) MOSFET

CHARACTERISTICS

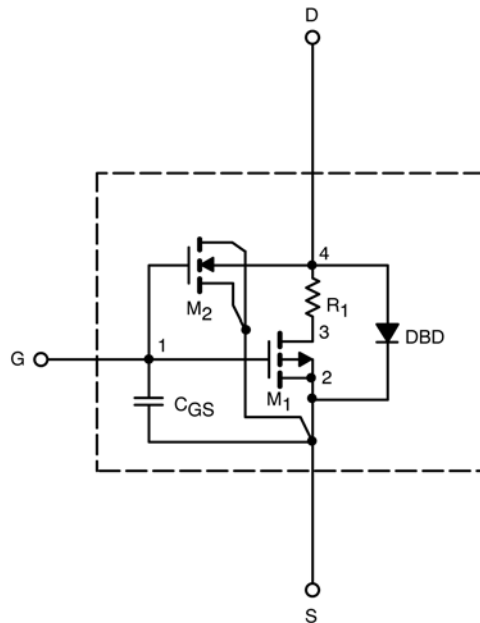
- P-Channel Vertical DMOS
- Macro Model (Subcircuit Model)
- Level 3 MOS
- Apply for both Linear and Switching Application
- Accurate over the -55 to 125°C Temperature Range
- Model the Gate Charge, Transient, and Diode Reverse Recovery Characteristics

DESCRIPTION

The attached spice model describes the typical electrical characteristics of the p-channel vertical DMOS. The subcircuit model is extracted and optimized over the -55 to 125°C temperature ranges under the pulsed 0-V to 5-V gate drive. The saturated output impedance is best fit at the gate bias near the threshold voltage.

A novel gate-to-drain feedback capacitance network is used to model the gate charge characteristics while avoiding convergence difficulties of the switched C_{gd} model. All model parameter values are optimized to provide a best fit to the measured electrical data and are not intended as an exact physical interpretation of the device.

SUBCIRCUIT MODEL SCHEMATIC



This document is intended as a SPICE modeling guideline and does not constitute a commercial product data sheet. Designers should refer to the appropriate data sheet of the same number for guaranteed specification limits.



SPECIFICATIONS (T _J = 25°C UNLESS OTHERWISE NOTED)				
Parameter	Symbol	Test Conditions	Typical	Unit
Static				
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = -250 μA	0.85	V
On-State Drain Current ^a	I _{D(on)}	V _{DS} = -5 V, V _{GS} = -4.5 V	37.5	A
		V _{DS} = -5 V, V _{GS} = -2.5 V	10.5	
Drain-Source On-State Resistance ^a	r _{DS(on)}	V _{GS} = -4.5 V, I _D = -3.3 A	0.078	Ω
		V _{GS} = -2.5 V, I _D = -2.9 A	0.011	
Forward Transconductance ^a	g _{fs}	V _{DS} = -10 V, I _D = -3.3 A	8	S
Diode Forward Voltage ^a	V _{SD}	I _S = -1.6 A, V _{GS} = 0 V	0.8	V
Dynamic^b				
Total Gate Charge ^b	Q _g	V _{DS} = -10 V, V _{GS} = -4.5 V, I _D = -3.3 A	8.8	nC
Gate-Source Charge ^b	Q _{gs}		1.5	
Gate-Drain Charge ^b	Q _{gd}		3	
Turn-On Delay Time ^{b,c}	t _{d(on)}	V _{DD} = -10 V, R _L = 10 Ω I _D ≅ -1.6 A, V _{GEN} = -4.5 V, R _G = 6 Ω	5.3	ns
Rise Time ^{b,c}	t _r		15	
Turn-Off Delay Time ^{b,c}	t _{d(off)}		51	
Fall Time ^{b,c}	t _f		14	
Source-Drain Reverse Recovery Time	t _{rr}	I _F = I _S = -1.6 A, di/dt = 100 A/μs	50	

Notes

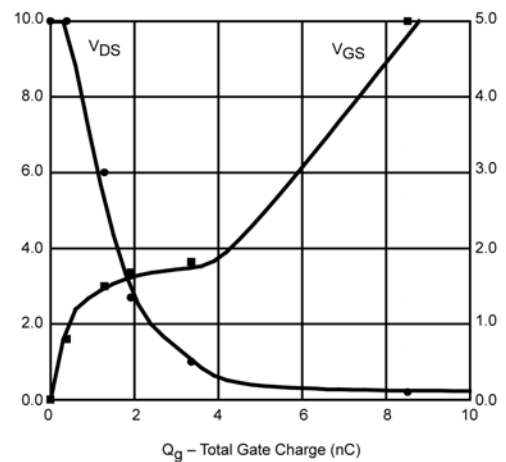
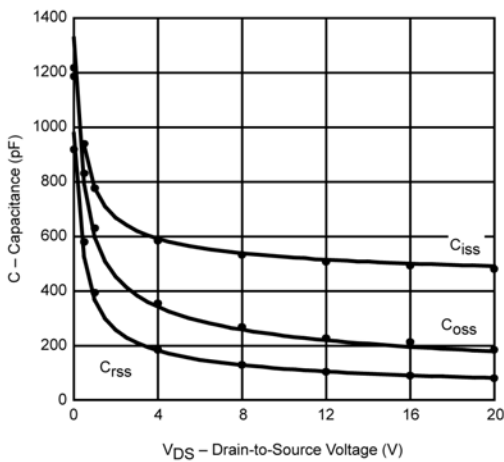
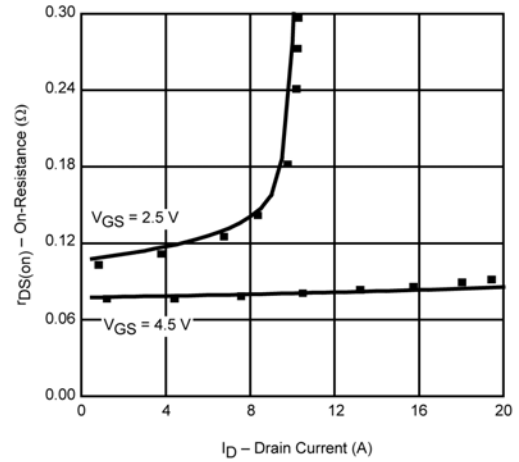
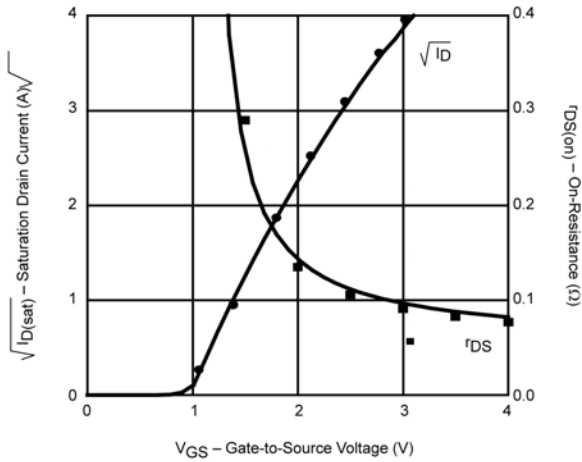
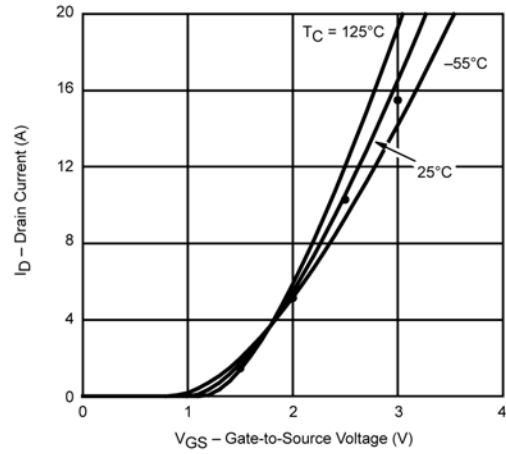
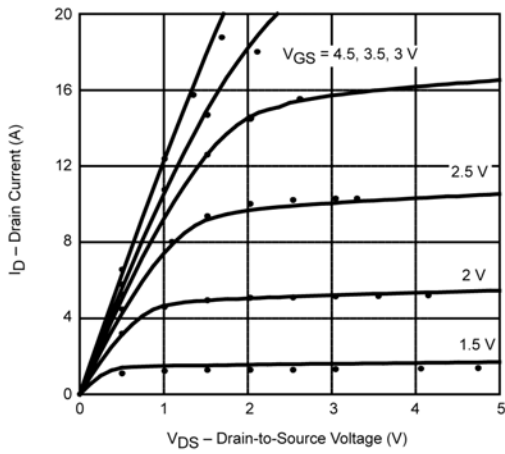
- a. Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2%.
- b. Independent of operating temperature.
- c. Include only parasitic components presented in the model circuit.



SPICE Device Model Si3441DV

Vishay Siliconix

COMPARISON OF MODEL WITH MEASURED DATA ($T_J=25^\circ\text{C}$ UNLESS OTHERWISE NOTED)



Note: Dots and squares represent measured data.



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